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Details

Product Status	Active
Core Processor	12V1
Core Size	16-Bit
Speed	25MHz
Connectivity	IrDA, LINbus, SCI, SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	28
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	512 x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	3.13V ~ 5.5V
Data Converters	A/D 6x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/s9s12vrp64f0vlf

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Port Integration Module (S12VRPIMV3)

2.3.42 Port AD Input Register (PTI1AD)



Write:Never

1

1

Table 2-42. PTI1AD Register Field Descriptions

Field	Description
5-0	PorT Input data register 1 port AD —
PTI1AD	A read always returns the synchronized input state of the associated pin if the ADC Digital Input Enable Register (ATDDIEN)
	is set to 1. Else a logic 1 is read. It can be used to detect overload or short circuit conditions on output pins.

2.4.2.8 Interrupt enable register (PIEx)

If the pin is used as an interrupt input this register serves as a mask to the interrupt flag to enable/disable the interrupt.

2.4.2.9 Interrupt flag register (PIFx)

If the pin is used as an interrupt input this register holds the interrupt flag after a valid pin event.

2.4.2.10 Module routing register (MODRRx)

Routing registers allow software re-configuration of specific peripheral inputs and outputs:

- MODRR0 selects the driving source of the HSDRV and LSDRV pins
- MODRR1 selects optional pins for PWM channels and ETRIG inputs (S12VR64/48 only)
- MODRR2 supports options to test the internal SCI-LINPHY interface signals

2.4.3 Pins and Ports

NOTE

Please refer to the device pinout section to determine the pin availability in the different package options.

2.4.3.1 BKGD pin

The BKGD pin is associated with the BDM module.

During reset, the BKGD pin is used as MODC input.

2.4.3.2 Port E

This port is associated with the CPMU OSC.

Port E pins PE1-0 can be used for general-purpose or with the CPMU OSC module.

2.4.3.3 Port T

This port is associated with TIM, routed SCI-LINPHY interface and routed SPI.

Port T pins can be used for either general-purpose I/O or with the channels of the standard TIM, SPI, or SCI and LINPHY subsystems.

2.4.3.4 Port S

This port is associated with the API_EXTCLK, ECLK, SPI, SCI1, routed SCI0, routed PWM channels and ETRIG inputs.

Port S pins can be used either for general-purpose I/O, or with the ECLK, SPI, SCI, and PWM subsystems.

- Enable the external oscillator (OSCE bit)
- Wait for oscillator to start up (UPOSC=1)
- Select the Oscillator Clock (OSCCLK) as source of the Bus Clock (PLLSEL=0).
- The PLLCLK is on and used to qualify the external oscillator clock.

4.1.2.2 Wait Mode

For S12CPMU_UHV_V8 Wait Mode is the same as Run Mode.

4.1.2.3 Stop Mode

This mode is entered by executing the CPU STOP instruction.

The voltage regulator is in Reduced Performance Mode (RPM).

NOTE

The voltage regulator output voltage may degrade to a lower value than in Full Performance Mode (FPM), additionally the current sourcing capability is substantially reduced (see also Appendix for VREG electrical parameters). Only clock source ACLK is available and the Power On Reset (POR) circuitry is functional. The Low Voltage Interrupt (LVI) and Low Voltage Reset (LVR) are disabled.

The API is available.

The Phase Locked Loop (PLL) is off.

The Internal Reference Clock (IRC1M) is off.

Core Clock, Bus Clock and BDM Clock are stopped.

Depending on the setting of the PSTP and the OSCE bit, Stop Mode can be differentiated between Full Stop Mode (PSTP = 0 or OSCE=0) and Pseudo Stop Mode (PSTP = 1 and OSCE=1). In addition, the behavior of the COP in each mode will change based on the clocking method selected by COPOSCSEL[1:0].

• Full Stop Mode (PSTP = 0 or OSCE=0)

External oscillator (XOSCLCP) is disabled.

— If COPOSCSEL1=0:

The COP and RTI counters halt during Full Stop Mode.

After wake-up from Full Stop Mode the Core Clock and Bus Clock are running on PLLCLK (PLLSEL=1). COP and RTI are running on IRCCLK (COPOSCSEL0=0, RTIOSCSEL=0).

— If COPOSCSEL1=1:

The clock for the COP is derived from ACLK (trimmable internal RC-Oscillator clock). During Full Stop Mode the ACLK for the COP can be stopped (COP static) or running (COP active) depending on the setting of bit CSAD. When bit CSAD is set the ACLK clock source for the COP is stopped during Full Stop Mode and COP continues to operate after exit from Full Stop

S12 Clock, Reset and Power Management Unit (S12CPMU_UHV_V8)

VDDX has to be connected externally to VDDA.

4.2.6 VSS— Ground Pin

VSS is the ground pin for the core logic. On the board VSSX, VSSA and VSS need to be connected together to the application ground.

4.2.7 API_EXTCLK — API external clock output pin

This pin provides the signal selected via APIES and is enabled with APIEA bit. See the device specification if this clock output is available on this device and to which pin it might be connects.

4.2.8 VDD— Internal Regulator Output Supply (Core Logic)

Node VDD is a device internal supply output of the voltage regulator that provides the power supply for the core logic.

This supply domain is monitored by the Low Voltage Reset circuit.

4.2.9 VDDF— Internal Regulator Output Supply (NVM Logic)

Node VDDF is a device internal supply output of the voltage regulator that provides the power supply for the NVM logic.

This supply domain is monitored by the Low Voltage Reset circuit.

4.2.10 **TEMPSENSE** — Internal Temperature Sensor Output Voltage

Depending on the VSEL setting either the voltage level generated by the temperature sensor or the VREG bandgap voltage is driven to a special channel input of the ADC Converter. See device level specification for connectivity of ADC special channels.

S12S Debug Module (S12DBGV2)

6.2 External Signal Description

There are no external signals associated with this module.

6.3 Memory Map and Registers

6.3.1 Module Memory Map

A summary of the registers associated with the DBG sub-block is shown in Figure 6-2. Detailed descriptions of the registers and bits are given in the subsections that follow.

Address	Name		Bit 7	6	5	4	3	2	1	Bit 0	
0x0020	DBGC1	R W	ARM	0 TRIG	0	BDM	DBGBRK	0	COM	/IRV	
0x0021	DBGSR	R	¹ TBF	0	0	0	0	SSF2	SSF1	SSF0	
0.00021	DDODR	W									
0x0022	DBGTCR	R W	0	TSOURCE	0	0	TRC	MOD	0	TALIGN	
0x0023	DBGC2	R W	0	0	0	0	0	0	AB	СМ	
0x0024	DBGTBH	R W	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	
0x0025	DBGTBL	R W	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0.000	DDCONT	Г W	¹ TBF	0			CN	T			
0x0026	DBGCNI										
0x0027	DBGSCRX	R W	0	0	0	0	SC3	SC2	SC1	SC0	
0x0027	DBGMFR	R	0	0	0	0	0	MC2	MC1	MC0	
		W									
² 0x0028	DBGACTL	R W	SZE	SZ	TAG	BRK	RW	RWE	NDB	COMPE	
³ 0x0028	DBGBCTL	R W	SZE	SZ	TAG	BRK	RW	RWE	0	COMPE	
⁴ 0x0028	DBGCCTL	DBGCCTL	R R	0	0	TAG	BRK	RW	RWE	0	COMPE
		W									
0x0029	DBGXAH	R W	0	0	0	0	0	0	Bit 17	Bit 16	
0x002A	DBGXAM	R W	Bit 15	14	13	12	11	10	9	Bit 8	
0x002B	DBGXAL	R W	Bit 7	6	5	4	3	2	1	Bit 0	

Figure 6-2. Quick Reference to DBG Registers

6.3.2.7.1 Debug State Control Register 1 (DBGSCR1)

Address: 0x0027



Figure 6-9. Debug State Control Register 1 (DBGSCR1)

Read: If COMRV[1:0] = 00

Write: If COMRV[1:0] = 00 and DBG is not armed.

This register is visible at 0x0027 only with COMRV[1:0] = 00. The state control register 1 selects the targeted next state whilst in State1. The matches refer to the match channels of the comparator match control logic as depicted in Figure 6-1 and described in Section 6.3.2.8.1, "Debug Comparator Control Register (DBGXCTL). Comparators must be enabled by setting the comparator enable bit in the associated DBGXCTL control register.

Table 6-15. DBGSCR1	Field	Descriptions
---------------------	-------	--------------

Field	Description
3–0 SC[3:0]	These bits select the targeted next state whilst in State1, based upon the match event.

SC[3:0]	Description (Unspecified matches have no effect)
0000	Any match to Final State
0001	Match1 to State3
0010	Match2 to State2
0011	Match1 to State2
0100	Match0 to State2 Match1 to State3
0101	Match1 to State3Match0 to Final State
0110	Match0 to State2 Match2 to State3
0111	Either Match0 or Match1 to State2
1000	Reserved
1001	Match0 to State3
1010	Reserved
1011	Reserved
1100	Reserved
1101	Either Match0 or Match2 to Final StateMatch1 to State2
1110	Reserved
1111	Reserved

Table 6-16. State1 Sequencer Next State Selection

The priorities described in Table 6-36 dictate that in the case of simultaneous matches, a match leading to final state has priority followed by the match on the lower channel number (0,1,2). Thus with SC[3:0]=1101 a simultaneous match0/match1 transitions to final state.

Pulse-Width Modulator (S12PWM8B8CV2)

Register Name		Bit 7	6	5	4	3	2	1	Bit 0
PWMCLKAB	R W	PCLKAB7	PCLKAB6	PCLKAB5	PCLKAB4	PCLKAB3	PCLKAB2	PCLKAB1	PCLKAB0
RESERVED	R	0	0	0	0	0	0	0	0
	W								
PWMSCLA	R W	Bit 7	6	5	4	3	2	1	Bit 0
PWMSCLB	R W	Bit 7	6	5	4	3	2	1	Bit 0
RESERVED	R	0	0	0	0	0	0	0	0
	W								
RESERVED	R	0	0	0	0	0	0	0	0
	W								
PWMCNT0 ²	R	Bit 7	6	5	4	3	2	1	Bit 0
	W	0	0	0	0	0	0	0	0
PWMCNT1 ²	R	Bit 7	6	5	4	3	2	1	Bit 0
	W	0	0	0	0	0	0	0	0
PWMCNT2 ²	R	Bit 7	6	5	4	3	2	1	Bit 0
	W	0	0	0	0	0	0	0	0
PWMCNT3 ²	R	Bit 7	6	5	4	3	2	1	Bit 0
	W	0	0	0	0	0	0	0	0
PWMCNT4 ²	R	Bit 7	6	5	4	3	2	1	Bit 0
	W	0	0	0	0	0	0	0	0
PWMCNT5 ²	R	Bit 7	6	5	4	3	2	1	Bit 0
	W	0	0	0	0	0	0	0	0
PWMCNT6 ²	R	Bit 7	6	5	4	3	2	1	Bit 0
	W	0	0	0	0	0	0	0	0
PWMCNT7 ²	R	Bit 7	6	5	4	3	2	1	Bit 0
	W	0	0	0	0	0	0	0	0
PWMPER0 ²	R W	Bit 7	6	5	4	3	2	1	Bit 0
	[= Unimpleme	nted or Reserve	d				

Figure 9-2. The scalable PWM Register Summary (Sheet 2 of 4)

9.4.2 PWM Channel Timers

The main part of the PWM module are the actual timers. Each of the timer channels has a counter, a period register and a duty register (each are 8-bit). The waveform output period is controlled by a match between the period register and the value in the counter. The duty is controlled by a match between the duty register and the counter value and causes the state of the output to change during the period. The starting polarity of the output is also selectable on a per channel basis. Shown below in Figure 9-16 is the block diagram for the PWM timer.



PWMEx

Figure 9-16. PWM Timer Channel Block Diagram

9.4.2.1 PWM Enable

Each PWM channel has an enable bit (PWMEx) to start its waveform output. When any of the PWMEx bits are set (PWMEx = 1), the associated PWM output signal is enabled immediately. However, the actual PWM waveform is not available on the associated PWM output until its clock source begins its next cycle due to the synchronization of PWMEx and the clock source. An exception to this is when channels are concatenated. Refer to Section 9.4.2.7, "PWM 16-Bit Functions" for more detail.

NOTE

The first PWM cycle after enabling the channel can be irregular.

Serial Peripheral Interface (S12SPIV5) for S12VR64

11.2.3 \overline{SS} — Slave Select Pin

This pin is used to output the select signal from the SPI module to another peripheral with which a data transfer is to take place when it is configured as a master and it is used as an input to receive the slave select signal when the SPI is configured as slave.

11.2.4 SCK — Serial Clock Pin

In master mode, this is the synchronous output clock. In slave mode, this is the synchronous input clock.

11.3 Memory Map and Register Definition

This section provides a detailed description of address space and registers used by the SPI.

11.3.1 Module Memory Map

The memory map for the SPI is given in Figure 11-2. The address listed for each register is the sum of a base address and an address offset. The base address is defined at the SoC level and the address offset is defined at the module level. Reads from the reserved bits return zeros and writes to the reserved bits have no effect.

Register Name		Bit 7	6	5	4	3	2	1	Bit 0			
SPICR1	R W	SPIE	SPE	SPTIE	MSTR	CPOL	СРНА	SSOE	LSBFE			
SPICR2	R W	0	XFRW	0	MODFEN	BIDIROE	0	SPISWAI	SPC0			
SPIBR	R W	0	SPPR2	SPPR1	SPPR0	0	SPR2	SPR1	SPR0			
SPISR	R W	SPIF	0	SPTEF	MODF	0	0	0	0			
SPIDRH	R W	R15 T15	R14 T14	R13 T13	R12 T12	R11 T11	R10 T10	R9 T9	R8 T8			
SPIDRL	R W	R7 T7	R6 T6	R5 T5	R4 T4	R3 T3	R2 T2	R1 T1	R0 T0			
Reserved	R W											
Reserved	R W											
	Γ		= Unimpleme	= Unimplemented or Reserved								

Figure 11-2. SPI Register Summary

12.1.2 Modes of Operation

Stop:	Timer is off because clocks are stopped.
-------	------------------------------------------

- Freeze: Timer counter keeps on running, unless TSFRZ in TSCR1 is set to 1.
- Wait: Counters keeps on running, unless TSWAI in TSCR1 is set to 1.
- Normal: Timer counter keep on running, unless TEN in TSCR1 is cleared to 0.

12.1.3 Block Diagrams



Figure 12-1. TIM16B4CV3 Block Diagram

LIN Physical Layer (S12LINPHYV2)

16.3.2 Register Descriptions

This section describes all the LIN Physical Layer registers and their individual bits.

16.3.2.1 Port LP Data Register (LPDR)



¹ Read: Anytime

Write: Anytime

Table	16-2.	LPDR	Field	Description
-------	-------	------	-------	-------------

Field	Description
1 LPDR1	Port LP Data Bit 1 — The LIN Physical Layer LPTxD input (see Figure 16-1) can be directly controlled by this register bit. The routing of the LPTxD input is done in the Port Inetrgation Module (PIM). Please refer to the PIM chapter of the device Reference Manual for more info.
0 LPDR0	Port LP Data Bit 0 — Read-only bit. The LIN Physical Layer LPRxD output state can be read at any time.



1: Flag cleared, transmitter re-enable not successful because over-current is still present

- 2: Flag cleared, transmitter re-enable not successful because LPTxD is dominant
- 3: Flag cleared, transmitter re-enable successful

Figure 16-12. Overcurrent interrupt handling

16.4.4.2 TxD-dominant timeout Interrupt

To protect the LIN bus from a network lock-up, the LIN Physical Layer implements a TxD-dominant timeout mechanism. When the LPTxD signal has been dominant for more than t_{DTLIM} the transmitter is disabled and the LPDT status flag and the LPDTIF interrupt flag are set.

In order to re-enable the transmitter again, the following prerequisites must be met:

1) TxD-dominant condition is over (LPDT=0)

2) LPTxD is recessive or the LIN Physical Layer is in shutdown or receive only mode for a minimum of a transmit bit time

To re-enable the transmitter then, the LPDTIF flag must be cleared (by writing a 1).

NOTE

Please make sure that LPDTIF=1 before trying to clear it. It is not allowed to try to clear LPDTIF if LPDTIF=0 already.

NOTE

Register Address = Module Base Address + Address Offset, where the Module Base Address is defined at the MCU level and the Address Offset is defined at the module level.

Address Offset Register Name		Bit 7	6	5	4	3	2	1	Bit 0
0x0000	R	0	BVHS	BVI	S[1:0]	BSUAF	BSUSE	BSEAE	BSESE
DAIL	W		DVIIS	DVL	5[1.0]	DUCIL	DOCOL	DOLIAL	DOLOL
0x0001	R	0	0	0	0	0	0	BVHC	BVLC
BAISK	W								
0x0002 BATIE	R	0	0	0	0	0	0		
	W							BVHIE	BVLIE
0x0003	R	0	0	0	0	0	0		
BATIF	W							BVHIF	BVLIF
0x0004 - 0x0005	R	0	0	0	0	0	0	0	0
Reserved	W								
	-								
0x0006 - 0x0007 Reserved	R W	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved
	[= Unimpleme	ented					

Figure 17-2. BATS Register Summary

17.3.2 Register Descriptions

This section consists of register descriptions in address order. Each description includes a standard register diagram with an associated figure number. Details of register bit and field function follow the register diagrams, in bit order. Unused bits read back zero.



Figure 18-5. Flash Security Register (FSEC)

¹ Loaded from IFR Flash configuration field, during reset sequence.

All bits in the FSEC register are readable but not writable.

During the reset sequence, the FSEC register is loaded with the contents of the Flash security byte in the Flash configuration field at global address 0x3_FF0F located in P-Flash memory (see Table 18-4) as indicated by reset condition F in Figure 18-5. If a double bit fault is detected while reading the P-Flash phrase containing the Flash security byte during the reset sequence, all bits in the FSEC register will be set to leave the Flash module in a secured state with backdoor key access disabled.

Field	Description
7–6 KEYEN[1:0]	Backdoor Key Security Enable Bits — The KEYEN[1:0] bits define the enabling of backdoor key access to the Flash module as shown in Table 18-10.
5–2 RNV[5:2]	Reserved Nonvolatile Bits — The RNV bits should remain in the erased state for future enhancements.
1–0 SEC[1:0]	Flash Security Bits — The SEC[1:0] bits define the security state of the MCU as shown in Table 18-11. If the Flash module is unsecured using backdoor key access, the SEC bits are forced to 10.

Table 18-10. Flash KEYEN States

KEYEN[1:0]	Status of Backdoor Key Access
00	DISABLED
01	DISABLED ¹
10	ENABLED
11	DISABLED

¹ Preferred KEYEN state to disable backdoor key access.

Table 18-11. Flash Security States

SEC[1:0]	Status of Security
00	SECURED
01	SECURED ¹
10	UNSECURED
11	SECURED

¹ Preferred SEC state to set MCU to secured state.

The security function in the Flash module is described in Section 18.5 Security.

Field	Description
2 FPLDIS	Flash Protection Lower Address Range Disable — The FPLDIS bit determines whether there is a protected/unprotected area in a specific region of the P-Flash memory beginning with global address 0x3_8000. 0 Protection/Unprotection enabled 1 Protection/Unprotection disabled
1–0 FPLS[1:0]	Flash Protection Lower Address Size — The FPLS bits determine the size of the protected/unprotected area in P-Flash memory as shown in Table 18-20. The FPLS bits can only be written to while the FPLDIS bit is set.

FPOPEN	FPHDIS	FPLDIS	Function ¹
1	1	1	No P-Flash Protection
1	1	0	Protected Low Range
1	0	1	Protected High Range
1	0	0	Protected High and Low Ranges
0	1	1	Full P-Flash Memory Protected
0	1	0	Unprotected Low Range
0	0	1	Unprotected High Range
0	0	0	Unprotected High and Low Ranges

Table 18-18. P-Flash Protection Function

¹ For range sizes, refer to Table 18-19 and Table 18-20.

Table 18-19. P-Flash Protection Higher Address Range

FPHS[1:0]	Global Address Range	Protected Size
00	0x3_F800-0x3_FFFF	2 Kbytes
01	0x3_F000-0x3_FFFF	4 Kbytes
10	0x3_E000-0x3_FFFF	8 Kbytes
11	0x3_C000-0x3_FFFF	16 Kbytes

Table 18-20. P-Flash Protection Lower Address Range

FPLS[1:0]	Global Address Range	Protected Size
00	0x3_8000-0x3_83FF	1 Kbyte
01	0x3_8000-0x3_87FF	2 Kbytes
10	0x3_8000-0x3_8FFF	4 Kbytes
11	0x3_8000-0x3_9FFF	8 Kbytes

All possible P-Flash protection scenarios are shown in Figure 18-13. Although the protection scheme is loaded from the Flash memory at global address 0x3_FF0C during the reset sequence, it can be changed by the user. The P-Flash protection scheme can be used by applications requiring reprogramming in Normal Single Chip Mode while providing as much protection as possible if reprogramming is not required.

64 KByte Flash Module (S12FTMRG64K512V1) for S12VR64

CCOBIX[2:0]	FCCOB Parameters		
000	0x12	Global address [17:16] to identify EEPROM block	
001	Global address [15:0] anywhere within the sector to be erased. See Section 18.1.2.2 EEPROM Features for EEPROM sector size.		

Table 18-64. Er	ase EEPROM Sector	Command FCCO	B Requirements
-----------------	-------------------	--------------	----------------

Upon clearing CCIF to launch the Erase EEPROM Sector command, the Memory Controller will erase the selected Flash sector and verify that it is erased. The CCIF flag will set after the Erase EEPROM Sector operation has completed.

Register	Error Bit	Error Condition
FSTAT	ACCERR	Set if CCOBIX[2:0] != 001 at command launch
		Set if command not available in current mode (see Table 18-27)
		Set if an invalid global address [17:0] is suppliedsee)
		Set if a misaligned word address is supplied (global address [0] != 0)
	FPVIOL	Set if the selected area of the EEPROM memory is protected
	MGSTAT1	Set if any errors have been encountered during the verify operation
	MGSTAT0	Set if any non-correctable errors have been encountered during the verify operation

Table 18-65. Erase EEPROM Sector Command Error Handling

18.4.7 Interrupts

The Flash module can generate an interrupt when a Flash command operation has completed or when a Flash command operation has detected an ECC fault.

Table 18-66.	. Flash	Interrupt	Sources
--------------	---------	-----------	---------

Interrupt Source	Interrupt Flag	Local Enable	Global (CCR) Mask
Flash Command Complete	CCIF (FSTAT register)	CCIE (FCNFG register)	I Bit
ECC Double Bit Fault on Flash Read	DFDIF (FERSTAT register)	DFDIE (FERCNFG register)	I Bit
ECC Single Bit Fault on Flash Read	SFDIF (FERSTAT register)	SFDIE (FERCNFG register)	I Bit

NOTE

Vector addresses and their relative interrupt priority are determined at the MCU level.

32 KByte Flash Module (S12FTMRG32K128V1) for S12VR32

FCMD	Command	Function on EEPROM Memory
0x08	Erase All Blocks	Erase all EEPROM (and P-Flash) blocks. An erase of all Flash blocks is only possible when the FPLDIS, FPHDIS, and FPOPEN bits in the FPROT register and the DPOPEN bit in the EEPROT register are set prior to launching the command.
0x09	Erase Flash Block	Erase a EEPROM (or P-Flash) block. An erase of the full EEPROM block is only possible when DPOPEN bit in the EEPROT register is set prior to launching the command.
0x0B	Unsecure Flash	Supports a method of releasing MCU security by erasing all EEPROM (and P-Flash) blocks and verifying that all EEPROM (and P-Flash) blocks are erased.
0x0D	Set User Margin Level	Specifies a user margin read level for the EEPROM block.
0x0E	Set Field Margin Level	Specifies a field margin read level for the EEPROM block (special modes only).
0x10	Erase Verify EEPROM Section	Verify that a given number of words starting at the address provided are erased.
0x11	Program EEPROM	Program up to four words in the EEPROM block.
0x12	Erase EEPROM Sector	Erase all bytes in a sector of the EEPROM block.

Table 19-29. EEPROM Commands

19.4.5 Allowed Simultaneous P-Flash and EEPROM Operations

Only the operations marked 'OK' in Table 19-30 are permitted to be run simultaneously on the Program Flash and EEPROM blocks. Some operations cannot be executed simultaneously because certain hardware resources are shared by the two memories. The priority has been placed on permitting Program Flash reads while program and erase operations execute on the EEPROM, providing read (P-Flash) while write (EEPROM) functionality.

	EEPROM						
Program Flash	Read	Margin Read ¹	Program	Sector Erase	Mass Erase ²		
Read		ОК	OK	OK			
Margin Read ¹							
Program							
Sector Erase							
Mass Erase ²					OK		

Table 19-30. Allowed P-Flash and EEPROM Simultaneous Operations

¹ A 'Margin Read' is any read after executing the margin setting commands 'Set User Margin Level' or 'Set Field Margin Level' with anything but the 'normal' level specified. See the Note on margin settings in Section 19.4.6.12 Set User Margin Level Command and Section 19.4.6.13 Set Field Margin Level Command.

² The 'Mass Erase' operations are commands 'Erase All Blocks' and 'Erase Flash Block'

MCU Electrical Specifications

ATD Electrical Specifications



Figure C-1. ATD Accuracy Definitions

NOTE

Figure A-1 shows only definitions, for specification values refer to Table A-3 and Table A-4.

Table C-3. ATD Conversion Performance 5V range

P.34 0x0300-0x03FF Reserved

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x0300- 0x03FF Re	Pasaruad	R	0	0	0	0	0	0	0	0
	Reserveu	W								